

Attorney Docket No. 108298744US
Micron Docket No. 2003-0477.00/US

Used in Lieu of PTO/SB/08A/B
(Based on PTO 01-08 version)

Substitute for form 1449/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(Use as many sheets as necessary)</i>				Complete if Known	
				Application Number	10/733,226-Conf. #8010
				Filing Date	December 10, 2003
				First Named Inventor	William M. Hiatt
				Art Unit	2811
				Examiner Name	C. A. Matthews
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U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code ² (if known)			
	*	US-11/848,836		Jeung et al.	
	*	US-11/951,751		Sulfridge	
	*	US-11/966,824		Pratt et al.	
	*	US-11/863,579		Lee	
	*	US-11/774,419		Hutto	
	*	US-2,821,959	02-04-1958	Franz	
	*	US-3,006,318	10-31-1961	Monroe, Jr. et al.	
	*	US-3,865,298	02-11-1975	Allen et al.	
	*	US-4,368,106	01-11-1983	Anthony	
	*	US-4,534,100	08-13-1985	Lane	
	*	US-4,608,480	08-26-1986	Bizot et al.	
	*	US-4,614,427	09-30-1986	Koizumi et al.	
	*	US-4,660,063	04-21-1987	Anthony	
	*	US-4,756,765	07-12-1988	Woodroffe	
	*	US-4,768,291	09-06-1988	Palmer	
	*	US-4,959,705	09-25-1990	Lemnios et al.	
	*	US-4,964,212	10-23-1990	Deroux-Dauphin et al.	
	*	US-4,984,597	01-15-1991	McConnell et al.	
	*	US-5,024,966	06-18-1991	Dietrich et al.	
	*	US-5,026,964	06-25-1991	Somers et al.	
	*	US-5,027,184	06-25-1991	Soclof	
	*	US-5,037,782	08-06-1991	Nakamura et al.	
	*	US-5,123,902	06-23-1992	Muller et al.	
	*	US-5,145,099	09-08-1992	Wood et al.	
	*	US-5,158,911	10-27-1992	Quentin et al.	
	*	US-5,233,448	08-03-1993	Wu et al.	
	*	US-5,289,631	03-01-1994	Koopman et al.	
	*	US-5,292,686	03-08-1994	Riley et al.	
	*	US-5,294,568	03-15-1994	McNeilly et al.	
	*	US-5,378,312	01-03-1995	Gifford et al.	
	*	US-5,402,435	03-28-1995	Shiono et al.	
	*	US-5,406,630	04-11-1995	Piosenka et al.	

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	*	US-5,424,573	06-13-1995	Kato et al.	
	*	US-5,447,871	09-05-1995	Goldstein	
	*	US-5,464,960	11-07-1995	Hall et al.	
	*	US-5,496,755	03-05-1996	Bayraktaroglu	
	*	US-5,518,956	05-21-1996	Liu et al.	
	*	US-5,585,675	12-17-1996	Knopf	
	*	US-5,614,743	03-25-1997	Mochizuki et al.	
	*	US-5,627,106	05-06-1997	Hsu et al.	
	*	US-5,646,067	07-08-1997	Gaul	
	*	US-5,654,221	08-05-1997	Cronin et al.	
	*	US-5,673,846	10-07-1997	Gruber	
	*	US-5,718,791	02-17-1998	Spengler et al.	
	*	US-5,723,904	03-03-1998	Shiga et al.	
	*	US-5,771,158	06-23-1998	Yamagishi et al.	
	*	US-5,773,359	06-30-1998	Mitchell et al.	
	*	US-5,776,824	07-07-1998	Farnworth et al.	
	*	US-5,807,439	09-15-1998	Akatsu et al.	
	*	US-5,811,799	09-22-1998	Wu	
	*	US-5,821,532	10-13-1998	Beaman et al.	
	*	US-5,825,080	10-20-1998	Imaoka et al.	
	*	US-5,826,628	10-27-1998	Hamilton	
	*	US-5,851,845	12-22-1998	Wood et al.	
	*	US-5,857,963	01-12-1999	Pelchy et al.	
	*	US-5,861,654	01-19-1999	Johnson	
	*	US-5,893,828	04-13-1999	Uram	
	*	US-5,904,499	05-18-1999	Pace	
	*	US-5,998,292	12-07-1999	Black et al.	
	*	US-6,004,867	12-21-1999	Kim et al.	
	*	US-6,008,070	12-28-1999	Farnworth	
	*	US-6,080,291	06-27-2000	Woodruff et al.	
	*	US-6,103,547	08-15-2000	Corisis et al.	
	*	US-6,107,180	08-22-2000	Munroe et al.	
	*	US-6,107,679	08-22-2000	Noguchi et al.	
	*	US-6,110,825	08-29-2000	Mastromatteo et al.	
	*	US-6,114,240	09-05-2000	Akram et al.	

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	*	US-6,124,634	09-26-2000	Akram et al.	
	*	US-6,130,141	10-10-2000	Degani et al.	
	*	US-6,133,622	10-17-2000	Corisis et al.	
	*	US-6,137,182	10-24-2000	Hause et al.	
	*	US-6,140,604	10-31-2000	Somers et al.	
	*	US-6,143,588	11-07-2000	Glenn	
	*	US-6,159,764	12-12-2000	Kinsman et al.	
	*	US-6,184,465	02-06-2001	Corisis	
	*	US-6,187,615	02-13-2001	Kim et al.	
	*	US-6,191,487	02-20-2001	Rodenbeck et al.	
	*	US-6,222,270	04-24-2001	Lee et al.	
	*	US-6,228,687	05-08-2001	Akram et al.	
	*	US-6,229,202	05-08-2001	Corisis	
	*	US-6,235,552	05-22-2001	Kwon et al.	
	*	US-6,246,108	06-12-2001	Corisis et al.	
	*	US-6,252,300	06-26-2001	Hsuan et al.	
	*	US-6,268,114	07-31-2001	Wen et al.	
	*	US-6,271,580	08-07-2001	Corisis	
	*	US-6,277,757	08-21-2001	Lin et al.	
	*	US-6,291,894	09-18-2001	Farnworth et al.	
	*	US-6,294,837	09-25-2001	Akram et al.	
	*	US-6,326,689	12-04-2001	Thomas	
	*	US-6,326,697	12-04-2001	Farnworth	
	*	US-20020005583	01-17-2002	Harada et al.	
	*	US-6,341,009	01-22-2002	O'Connor et al.	
	*	US-6,344,976	02-05-2002	Schoenfeld et al.	
	*	US-20020020898	02-21-2002	Vu et al.	
	*	US-6,359,328	03-19-2002	Dubin	
	*	US-6,372,548	04-16-2002	Bessho et al.	
	*	US-20020057468	05-16-2002	Segawa et al.	
	*	US-6,391,770	05-21-2002	Kosaki et al.	
	*	US-20020059722	05-23-2002	Murakami	
	*	US-20020094607	07-18-2002	Gebauer et al.	
	*	US-20020096729	07-25-2002	Tu et al.	
	*	US-6,437,441	08-20-2002	Yamamoto et al.	

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	*	US-6,441,487	08-27-2002	Elenius et al.	
	*	US-6,452,270	09-17-2002	Huang et al.	
	*	US-20020130390	09-19-2002	Ker et al.	
	*	US-6,459,039	10-01-2002	Bezama et al.	
	*	US-6,468,889	10-22-2002	Iacoponi et al.	
	*	US-6,486,083	11-26-2002	Mizuno et al.	
	*	US-6,486,549	11-26-2002	Chiang et al.	
	*	US-20020190371	12-19-2002	Mashino et al.	
	*	US-20030014895	01-23-2003	Lizotte	
	*	US-6,534,863	03-18-2003	Walker et al.	
	*	US-6,545,563	04-08-2003	Smith	
	*	US-6,555,782	04-29-2003	Isaji et al.	
	*	US-6,560,047	05-06-2003	Choi et al.	
	*	US-6,569,711	05-27-2003	Susko et al.	
	*	US-6,569,777	05-27-2003	Hsu et al.	
	*	US-6,576,531	06-10-2003	Peng et al.	
	*	US-6,580,174	06-17-2003	McCormick et al.	
	*	US-20030119308	06-26-2003	Geefay et al.	
	*	US-6,593,644	07-15-2003	Chiu et al.	
	*	US-6,614,033	09-02-2003	Suguro et al.	
	*	US-6,638,410	10-28-2003	Chen et al.	
	*	US-20030216023	11-20-2003	Wark et al.	
	*	US-6,658,818	12-09-2003	Kurth et al.	
	*	US-6,660,622	12-09-2003	Chen et al.	
	*	US-6,660,630	12-09-2003	Chang et al.	
	*	US-6,680,459	01-20-2004	Kanaya et al.	
	*	US-20040018712	01-29-2004	Plas et al.	
	*	US-6,699,787	03-02-2004	Mashino et al.	
	*	US-20040041261	03-04-2004	Kinsman	
	*	US-20040043607	03-04-2004	Farnworth et al.	
	*	US-20040073607	04-15-2004	Su et al.	
	*	US-6,746,971	06-08-2004	Ngo et al.	
	*	US-20040137661	07-15-2004	Murayama	
	*	US-20040137701	07-15-2004	Takao	
	*	US-6,770,958	08-03-2004	Wang et al.	

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	*	US-6,774,486	08-10-2004	Kinsman	
	*	US-6,777,244	08-17-2004	Pepper et al.	
	*	US-20040159958	08-19-2004	Funaki	
	*	US-6,780,749	08-24-2004	Masumoto et al.	
	*	US-20040178491	09-16-2004	Akram et al.	
	*	US-20040180539	09-16-2004	Yamamoto et al.	
	*	US-6,797,616	09-28-2004	Kinsman	
	*	US-20040192033	09-30-2004	Hara	
	*	US-20040198033	10-07-2004	Lee et al.	
	*	US-20040198040	10-07-2004	Geefay et al.	
	*	US-6,809,421	10-26-2004	Hayasaka et al.	
	*	US-20040219763	11-04-2004	Kim et al.	
	*	US-20040222082	11-11-2004	Gopalraja et al.	
	*	US-6,818,464	11-16-2004	Heschel et al.	
	*	US-6,828,175	12-07-2004	Wood et al.	
	*	US-20040245649	12-09-2004	Imaoka	
	*	US-20040255258	12-16-2004	Li	
	*	US-20040262753	12-30-2004	Kashiwazaki	
	*	US-6,838,377	01-04-2005	Tonami et al.	
	*	US-20050026443	02-03-2005	Goo et al.	
	*	US-20050037608	02-17-2005	Andricacos et al.	
	*	US-20050046002	03-03-2005	Lee et al.	
	*	US-20050064707	03-24-2005	Sinha	
	*	US-20050069782	03-31-2005	Elenius et al.	
	*	US-6,885,107	04-26-2005	Kinsman	
	*	US-20050106834	05-19-2005	Andry et al.	
	*	US-20050110095	05-26-2005	Shih et al.	
	*	US-20050110889	05-26-2005	Tuttle et al.	
	*	US-6,903,012	06-07-2005	Geefay et al.	
	*	US-6,903,442	06-07-2005	Wood et al.	
	*	US-20050136646	06-23-2005	Larnerd et al.	
	*	US-6,910,268	06-28-2005	Miller	
	*	US-20050139390	06-30-2005	Kim et al.	
	*	US-6,916,725	07-12-2005	Yamaguchi et al.	
	*	US-20050151228	07-14-2005	Tanida et al.	

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	*	US-20050164500	07-28-2005	Lindgren	
	*	US-20050184219	08-25-2005	Kirby	
	*	US-6,936,536	08-30-2005	Sinha	
	*	US-20050194169	09-08-2005	Tonomura	
	*	US-6,943,056	09-13-2005	Nemoto et al.	
	*	US-6,946,325	09-20-2005	Yean et al.	
	*	US-6,953,748	10-11-2005	Yamaguchi et al.	
	*	US-20050231626	10-20-2005	Tuttle et al.	
	*	US-20050236708	10-27-2005	Farnworth et al.	
	*	US-20050247894	11-10-2005	Watkins et al.	
	*	US-20050253213	11-17-2005	Jiang et al.	
	*	US-20050254133	11-17-2005	Akram et al.	
	*	US-20050258530	11-24-2005	Vindasius et al.	
	*	US-6,970,775	11-29-2005	Lederle et al.	
	*	US-20050275048	12-15-2005	Farnworth et al.	
	*	US-20050275049	12-15-2005	Kirby et al.	
	*	US-20050275051	12-15-2005	Farnworth et al.	
	*	US-20050275750	12-15-2005	Akram et al.	
	*	US-20050277293	12-15-2005	Kim et al.	
	*	US-20050282374	12-22-2005	Hwang et al.	
	*	US-20050285154	12-29-2005	Akram et al.	
	*	US-6,982,487	01-03-2006	Kim et al.	
	*	US-20060011809	01-19-2006	Farnworth et al.	
	*	US-20060014313	01-19-2006	Hall et al.	
	*	US-20060023107	02-02-2006	Bolken et al.	
	*	US-20060024856	02-02-2006	Derderian et al.	
	*	US-20060035402	02-16-2006	Street et al.	
	*	US-20060035415	02-16-2006	Wood et al.	
	*	US-20060038183	02-23-2006	Oliver	
	*	US-20060038272	02-23-2006	Edwards	
	*	US-20060040421	02-23-2006	Farnworth et al.	
	*	US-20060040428	02-23-2006	Johnson	
	*	US-20060042952	03-02-2006	Oliver et al.	
	*	US-20060043262	03-02-2006	Akram	
	*	US-20060043509	03-02-2006	Watkins et al.	

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	*	US-20060043512	03-02-2006	Oliver et al.	
	*	US-20060043569	03-02-2006	Benson et al.	
	*	US-20060043599	03-02-2006	Akram et al.	
	*	US-20060044433	03-02-2006	Akram	
	*	US-20060046332	03-02-2006	Derderian et al.	
	*	US-20060046468	03-02-2006	Akram et al.	
	*	US-20060046537	03-02-2006	Chong et al.	
	*	US-20060057776	03-16-2006	Tao	
	*	US-20060057836	03-16-2006	Nagarajan et al.	
	*	US-7,022,609	04-04-2006	Yamamoto et al.	
	*	US-7,023,090	04-04-2006	Huang et al.	
	*	US-7,029,937	04-18-2006	Miyazawa et al.	
	*	US-7,033,927	04-25-2006	Cohen et al.	
	*	US-7,041,598	05-09-2006	Sharma	
	*	US-20060148250	07-06-2006	Kirby	
	*	US-20060151880	07-13-2006	Tang et al.	
	*	US-20060154153	07-13-2006	Chiang et al.	
	*	US-20060160367	07-20-2006	Wai et al.	
	*	US-7,083,425	08-01-2006	Chong et al.	
	*	US-7,084,073	08-01-2006	Lee et al.	
	*	US-20060177959	08-10-2006	Boettiger et al.	
	*	US-20060177999	08-10-2006	Hembree et al.	
	*	US-7,092,284	08-15-2006	Braun et al.	
	*	US-20060180941	08-17-2006	Kirby et al.	
	*	US-7,094,677	08-22-2006	Yamamoto et al.	
	*	US-20060186097	08-24-2006	Watkins et al.	
	*	US-20060186492	08-24-2006	Boettiger et al.	
	*	US-20060191882	08-31-2006	Watkins et al.	
	*	US-20060199363	09-07-2006	Kirby et al.	
	*	US-20060204651	09-14-2006	Wai et al.	
	*	US-7,109,068	09-19-2006	Akram et al.	
	*	US-20060208360	09-21-2006	Yiu et al.	
	*	US-20060216862	09-28-2006	Rigg et al.	
	*	US-20060240687	10-26-2006	Chong et al.	
	*	US-20060252262	11-09-2006	Kazemi	

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	*	US-20060255443	11-16-2006	Hwang et al.	
	*	US-20060264041	11-23-2006	Rigg et al.	
	*	US-20060270108	11-30-2006	Farnworth et al.	
	*	US-20060278980	12-14-2006	Trezza et al.	
	*	US-20060278988	12-14-2006	Trezza et al.	
	*	US-20060281224	12-14-2006	Edelstein et al.	
	*	US-20060281243	12-14-2006	Trezza	
	*	US-7,151,009	12-19-2006	Kim et al.	
	*	US-20060289968	12-28-2006	Sulfridge	
	*	US-20060290001	12-28-2006	Sulfridge	
	*	US-20060292877	12-28-2006	Lake	
	*	US-20070004079	01-04-2007	Geefay et al.	
	*	US-7,164,565	01-16-2007	Takeda	
	*	US-20070012655	01-18-2007	Kwon et al.	
	*	US-7,166,247	01-23-2007	Kramer	
	*	US-20070020805	01-25-2007	Kim et al.	
	*	US-20070020935	01-25-2007	Taylor et al.	
	*	US-7,170,183	01-30-2007	Kim et al.	
	*	US-20070023121	02-01-2007	Jones et al.	
	*	US-20070032061	02-08-2007	Farnworth et al.	
	*	US-20070035033	02-15-2007	Ozguz et al.	
	*	US-20070037379	02-15-2007	Enquist et al.	
	*	US-20070042598	02-22-2007	Park	
	*	US-7,183,176	02-27-2007	Sankarapillai et al.	
	*	US-7,183,653	02-27-2007	Meyers et al.	
	*	US-20070045120	03-01-2007	Tiwari et al.	
	*	US-20070045388	03-01-2007	Farnworth et al.	
	*	US-20070045515	03-01-2007	Farnworth et al.	
	*	US-20070045632	03-01-2007	Oliver et al.	
	*	US-20070045779	03-01-2007	Hiatt	
	*	US-20070045806	03-01-2007	Hsuan	
	*	US-20070045812	03-01-2007	Heng	
	*	US-20070045826	03-01-2007	Lee et al.	
	*	US-20070045834	03-01-2007	Chong et al.	
	*	US-20070048896	03-01-2007	Andry et al.	

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	*	US-20070048994	03-01-2007	Tuttle	
	*	US-20070049016	03-01-2007	Hiatt et al.	
	*	US-20070049019	03-01-2007	Wai et al.	
	*	US-7,186,650	03-06-2007	Dakshina-Murthy	
	*	US-7,190,061	03-13-2007	Lee et al.	
	*	US-20070057028	03-15-2007	Lake et al.	
	*	US-7,199,050	04-03-2007	Hiatt	
	*	US-20070077753	04-05-2007	Iwatake et al.	
	*	US-20070082427	04-12-2007	Shirahama et al.	
	*	US-20070096263	05-03-2007	Furukawa et al.	
	*	US-20070099395	05-03-2007	Sridhar et al.	
	*	US-7,217,596	05-15-2007	Cobbley et al.	
	*	US-7,217,888	05-15-2007	Sunohara et al.	
	*	US-7,232,754	06-19-2007	Kirby et al.	
	*	US-20070138562	06-21-2007	Trezza	
	*	US-20070152342	07-05-2007	Tsao et al.	
	*	US-20070155997	07-05-2007	Li et al.	
	*	US-20070158839	07-12-2007	Trezza	
	*	US-20070158853	07-12-2007	Sinha	
	*	US-20070161235	07-12-2007	Trezza	
	*	US-20070166991	07-19-2007	Sinha	
	*	US-20070166997	07-19-2007	Knorr	
	*	US-20070167004	07-19-2007	Trezza	
	*	US-20070170574	07-26-2007	Lauxtermann et al.	
	*	US-20070178694	08-02-2007	Hiatt	
	*	US-20070182020	08-09-2007	Trezza et al.	
	*	US-7,256,073	08-14-2007	Noma et al.	
	*	US-20070190803	08-16-2007	Singh et al.	
	*	US-20070197013	08-23-2007	Trezza	
	*	US-7,262,134	08-28-2007	Kirby et al.	
	*	US-20070202617	08-30-2007	Hembree	
	*	US-7,265,052	09-04-2007	Sinha	
	*	US-7,271,482	09-18-2007	Kirby	
	*	US-20070222054	09-27-2007	Hembree	
	*	US-20070228576	10-04-2007	Trezza	

Attorney Docket No. 108298744US
Micron Docket No. 2003-0477.00/US

Used in Lieu of PTO/SB/08A/B
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	*	US-20070228926	10-04-2007	Teo et al.	
	*	US-20070262424	11-15-2007	Hiatt	
	*	US-7,300,857	11-27-2007	Akram et al.	
	*	US-20070281473	12-06-2007	Clark et al.	
	*	US-20080050911	02-28-2008	Borthakur	
	*	US-20080054444	03-06-2008	Tuttle	
	*	US-20080057620	03-06-2008	Pratt	

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Cite No. ¹	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages Or Relevant Figures Appear	T
		Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)				
		EP-0127946	12-12-1984	British Telecomm		
		JP-63052432	03-05-1988	Hitachi		
		JP-2001077496	03-23-2001	Ngk Insulators Ltd		
		JP-2001298147	10-26-2001	Kawasaki Steel Co		
		KR-20020022122	03-25-2002	Kermel		
		KR-20020061812	07-25-2002	Samsung Electronics Co Ltd		
		WO-2005022965	03-10-2005	Thermalworks Inc et al.		
		JP-2005093980	04-07-2005	Irvine Sensors Corp		
		WO-2005036940	04-21-2005	Qualcomm Inc et al.		
		JP-2005310817	11-04-2005	Seiko Epson Corp		
		WO-2006053036	05-18-2006	Unitive Internat Ltd et al.		
		WO-2006124597	11-23-2006	Foster Ron B et al.		
		WO-2007025812	03-08-2007	Forschungverbund Berlin E.V.		
		WO-2007043718	04-19-2007	Park		1

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NON PATENT LITERATURE DOCUMENTS				
Examiner Initials	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²	
		AACHBOUN, S. and P. RANSON, "Cryogenic etching of deep narrow trenches in silicon," J. Vac. Sci. Technol. A 18(4), July/Aug 2000, pp. 1848-1852.		
		AACHBOUN, S. and P. RANSON, "Deep anisotropic etching of silicon," J. Vac. Sci. Technol. A 17(4), Jul/Aug 1999, pp. 2270-2273.		
		ARUNASALAM, P. et al., "Thermo-Mechanical Analysis of Thru-Silicon-Via Based High Density Compliant Interconnect," Electronic Components and Technology Conference, 2007, ECTC '07, Proceedings, 57th, May 29, 2007 - June 1, 2007, pages 1179-1185.		
		BERNSTEIN, K. et al., "Interconnects in the Third Dimension: Design Challenges for 3D ICs," Design Automation Conference, 2007, DAC '07, 44th ACM/IEEE, June 4-8, 2007, pages 562-567.		
		CHEUNG, T.S.D. et al., "On-Chip Interconnect for mm-Wave Applications Using an All-Copper Technology and Wavelength Reduction," 2003 IEEE International Solid-State Circuits Conference.		
		CHOU, Bill et al., "Ultra Via Substrate for Advanced BGA Applications," Pan Pacific Symposium, January 25, 2000, < http://www.smta.org/files/PanPac00-ChouBill.pdf >.		
		HIRAFUNE, S. et al., "Packaging Technology for Imager Using Through-hole Interconnection in Si Substrate," Proceeding of HDP'04, IEEE, pp. 303-306, July 2004.		
		Kyocera Corporation, Memory Package, 1 page, retrieved from the Internet on December 3, 2004, < http://global.kyocera.com/prdct/semicon/ic_pkg/memory_p.html >.		
		LEE, Rex A. et al., "Laser Created Silicon Vias for Stacking Dies in MCMs," IEEE/CHMT IEMT Symposium, 1991, pp. 262-265.		
		LEE, T.K. et al., "A Novel Joint-in-Via Flip-Chip Chip-Scale Package," IEEE Transactions on Advanced Packaging, Vol. 29, No. 1, pp. 186-194, February 2006.		
		RASMUSSEN, F.E., et al., "Fabrication of High Aspect Ratio Through-Wafer Vias in CMOS Wafers for 3-D Packaging Applications," The 12th International Conference on Solid State Sensors, Actuators and Microsystems, Boston, June 8-12, 2003.		
		SAVASTIOUK, S. et al., "Thru-silicon interconnect technology," 26th IEEE/CPMT International Electronics Manufacturing Technology Symposium, 2000, abstract.		
		SCHAPER, L. et al., "Integrated System Development for 3-D VLSI," Electronic Components and Technology Conference, 2007, ECTC '07, Proceedings, 57th, May 29, 2007 - June 1, 2007, pages 853-857.		
		TAKAHASHI, K. et al., "Through Silicon Via and 3-D Wafer/Chip Stacking Technology," 2006 Symposium on VLSI Circuits Digest of Technical Papers.		
		TAKIZAWA, T. et al., "Conductive Interconnections Through Thick Silicon Substrates for 3D Packaging," The Fifteenth International Conference on Micro Electro Mechanical Systems, Las Vegas, January 20-24, 2002.		

Attorney Docket No. 108298744US
Micron Docket No. 2003-0477.00/US

Used in Lieu of PTO/SB/08A/B
(Based on PTO 01-08 version)

Substitute for form 1449/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(Use as many sheets as necessary)</i>				Complete if Known	
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				First Named Inventor	William M. Hiatt
				Art Unit	2811
				Examiner Name	C. A. Matthews
Sheet	12	of	12	Attorney Docket Number	108298744US

		TEZCAN, D.S. et al., "Sloped Through Wafer Vias for 3D Wafer Level Packaging," Electronic Components and Technology Conference, 2007, ECTC '07, Proceedings, 57th, May 29, 2007 - June 1, 2007, pages 643-647.	
		TRIGAS, C., "System-In-Package or System-On-Chip?," EE Times, September 19, 2003, < http://www.eetimes.com/story/OEG20030919S0049 >.	
		XSIL, xise200 for vias and micro-machining, < http://www.xsil.com/products/index/html >, retrieved from the Internet on August 16, 2003	
		YAMAMOTO, S. et al., "Si Through-Hole Interconnections Filled with Au-Sn Solder by Molten Metal Suction Method," pp. 642-645, IEEE, MEMS-03 Kyoto, The Sixteenth Annual International Conference on Micro Electro Mechanical Systems, January 2003, ISBN 0-7803-7744-3.	

Examiner Signature	/Colleen Matthews/	Date Considered	11/19/2009
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